



### Features :

- Isolated mounting base 3000V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

### Typical Applications

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V <sub>RSM</sub>	V <sub>RRM</sub>	Type & Outline
900V	800V	MDx26-08-223F3
1100V	1000V	MDx26-10-223F3
1300V	1200V	MDx26-12-223F3
1500V	1400V	MDx26-14-223F3
1700V	1600V	MDx26-16-223F3
1900V	1800V	MDx26-18-223F3

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T <sub>J</sub> (°C)	VALUE			UNIT
				Min	Type	Max	
I <sub>F(AV)</sub>	Mean forward current	180° half sine wave 50Hz Single side cooled, T <sub>C</sub> =100°C	150			26	A
I <sub>F (RMS)</sub>	RMS forward current		150			41	A
I <sub>RRM</sub>	Repetitive peak current	at V <sub>RRM</sub>	150			8	mA
I <sub>FSM</sub>	Surge forward current	10ms half sine wave	150			0.65	KA
I <sup>2</sup> t	I <sup>2</sup> T for fusing coordination	V <sub>R</sub> =0.6V <sub>RRM</sub>				2.1	A <sup>2</sup> s*10 <sup>3</sup>
V <sub>FO</sub>	Threshold voltage		150			0.80	V
r <sub>F</sub>	Forward slop resistance					6.80	mΩ
V <sub>FM</sub>	Peak forward voltage	I <sub>FM</sub> =80A	25			1.65	V
R <sub>th(j-c)</sub>	Thermal resistance Junction to case	At 180° sine Single side cooled per chip				1.300	°C /W
R <sub>th(c-h)</sub>	Thermal resistance case to heatsink	At 180° sine Single side cooled per chip				0.2	°C /W
V <sub>iso</sub>	Isolation voltage	50Hz, R.M.S, t=1min, I <sub>iso</sub> :1mA(max)		3000			V
F <sub>m</sub>	Terminal connection torque(M5)				4.0		N·m
	Mounting torque(M6)				6.0		N·m
T <sub>stg</sub>	Stored temperature			-40		125	°C
W <sub>t</sub>	Weight				160		g
Outline	223F3						

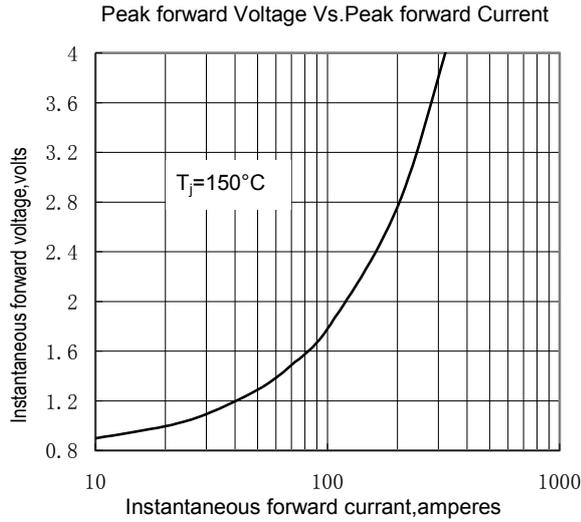


Fig. 1

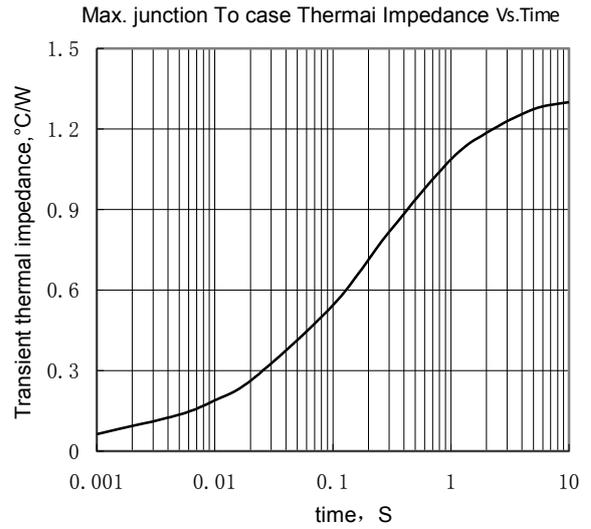


Fig. 2

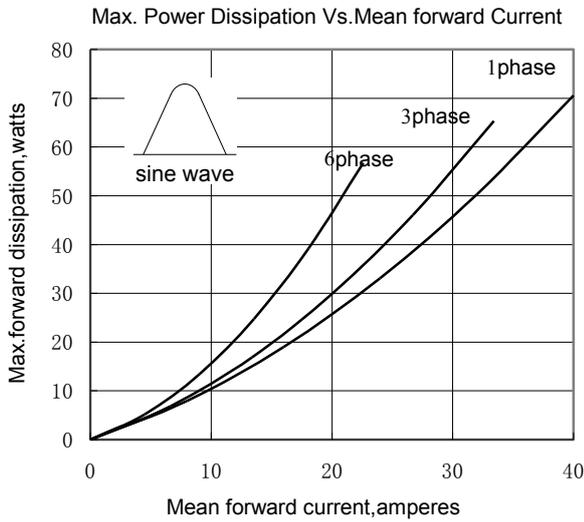


Fig. 3

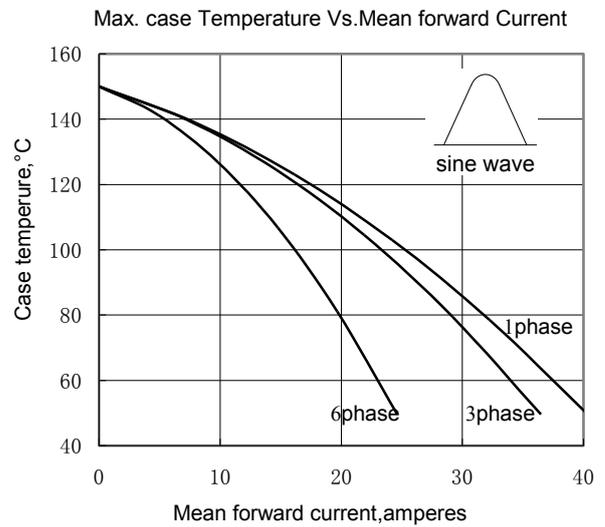


Fig. 4

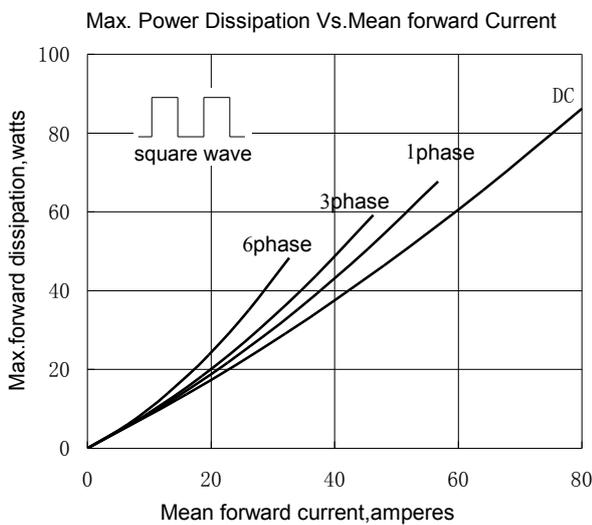


Fig. 5

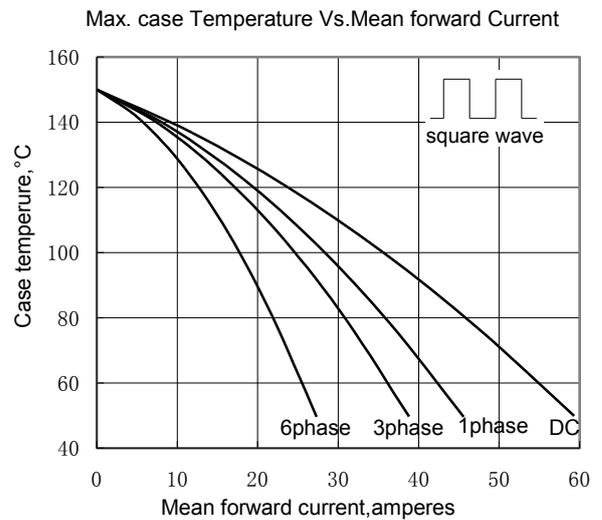


Fig. 6

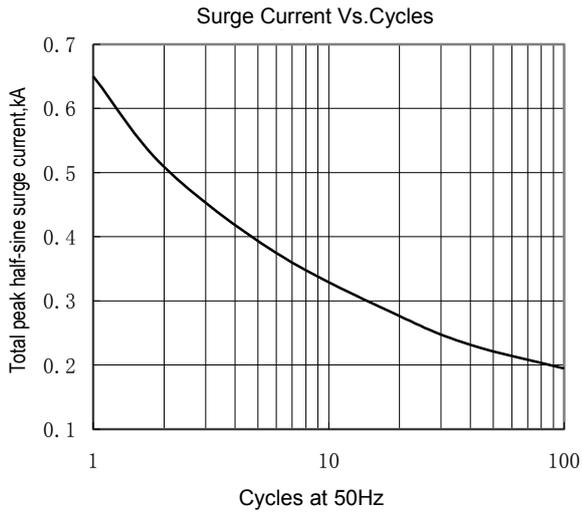


Fig.7

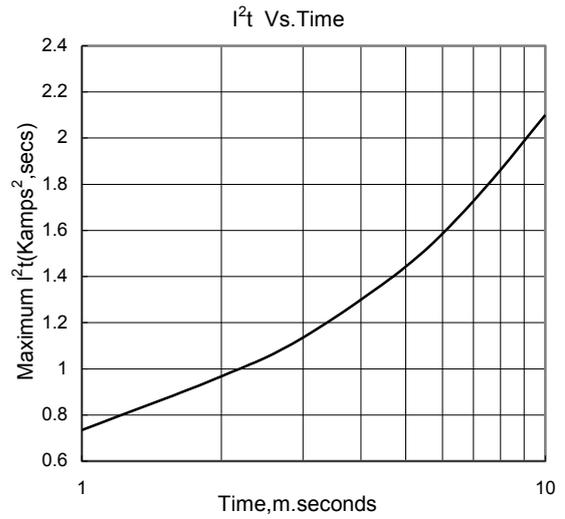


Fig.8

**Outline:**

